

RX Picosecond Lasers

TEM₀₀, Picosecond Lasers

With over 15 years of expertise in developing and refining picosecond laser features, performance, reliabilities, after delivering thousands of these RX series lasers, RX Series picosecond lasers deliver exceptional performance, precision, and durability, making them ideal for advanced industrial and scientific applications. our RX series excels in precision manufacturing, scientific research, and ultrafast laser processing. While maintaining consistent reliability and accuracy.

Photonics Industries has earned a reputation as a global leader in ultrafast laser technology. Each laser is built to rigorous quality standards, reflecting our commitment to innovation and customer satisfaction. Our proven track record demonstrates our ability to address complex challenges and deliver solutions that empower cutting-edge industries and research.



APPLICATIONS

- Marking & Scribing
- Medical Device Laser Micro processing
- Thin Film Removal and Processing
- PCB & Polymer Cutting & Drilling
- Selective Annealing and Doping
- Solar Cell Manufacturing
- Semiconductor Processing
- Micromachining Transparent Materials

FEATURES

- Up to ~900µJ Pulse Energy at 100kHz
- True TEM₀₀ Output, M² < 1.3
- Exceptional point stability (<25urad)
- Ultra-Short Pulse Widths (10ps @1064nm) (~7ps@ 532/355nm)
- Burst Mode for Pulse Control
- Robust & Compact Form Factor
- Dynamic Pulse Energy Control PEC
- Position Synchronized Output PSO
- Power Monitoring and Self-Calibration



Specifications – RX Series						
	RX-1064-40	RX-1064-100	RX-1064-150			
Wavelength		1064nm	·			
Average Power @ 1MHz	40W	100W	150W			
Pulse Energy @100kHz	~300µJ	~300µJ ~600µJ ~900µJ				
Pulse Width		~10ps				
Pulse repetition rate		Single shot to 2MHz				
Pulse-to-pulse stability		<1% rms				
Long-term power stability ¹		≤1% rms				
Beam spatial mode & M ^{2 †}	TEM ₀₀ - M ² <1.3	TEM ₀₀ - M ² <1.3 TEM ₀₀ - M ² <1.2				
Beam divergence (nominal)		<1.5 mrad				
Beam bore sight accuracy	≤ 1 mm lateral (to specified	\leq 1 mm lateral (to specified exit location), \leq 5 mrad angular (to specified exit direction)				
Beam roundness	>90%					
Beam pointing stability	<25 µrad					
Polarization ratio	Vertical; >100:1					
	Operatio	onal Specifications and Charac	teristics			
Interface	RS232, Eth	ernet, Software GUI, External TTI	Triggering			
Warm-up time	< 5 minutes	< 5 minutes from standby, <15 minutes from cold start				
Electrical requirement	32 V DC, 15 A	32 V DC, 28 A	60/32 V DC, 20/18 A			
Line frequency	50-60 Hz					
Power consumption	<500W	<500W <900W <1300W				
Dimensions	16 x 8.5 x 4.5 in. [406.4 x 215.9 x 114.3mm]	20 x 8.5 x 4.5 in. 20 x 10 x 4.5 [508 x 215.9 x 114.3mm] [508 x 254 x 114				
Weight	~38lbs [17.2kg]	~47lbs [21.3kg]	~57lbs [25.9kg]			
		Environmental Requirements				
Ambient temperature ?	Ambient 15°C to 30°C (59°F to 86°F) Operating Range					
Ambient temperature ²	Relative humidity 0% to 80% max, non-condensing					
Storage conditions	-10°C to 40°C; sea level to 12000 m					
Storage conditions	0% to 8	30% relative Humidity, non-cond	ensing			
Cooling system		Water-Cooled				

[1] Measured over 8 hours ± 2°C. [2] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate *Illustration includes some simulated data for conceptual visualization.

Typical Beam Profile







Specifications – **RX Series**

	RX-532-20	RX-532-70	RX-532-100			
Wavelength		532nm				
Average Power @ 1MHz ¹	25W	70W	100W			
Pulse Energy @100kHz ²	~180µJ	~400µJ	~600µJ			
Pulse Width		~7ps				
Pulse repetition rate		Single shot to 2MHz				
Pulse-to-pulse stability		<2% rms				
Long-term power stability ³		≤1% rms				
Beam spatial mode & M ^{2 †}	TEM ₀₀ - M ² <1.2					
Beam divergence (nominal)		< 1 mrad				
Beam bore sight accuracy	≤ 1 mm lateral (to specified	l exit location), ≤ 5 mrad angular	(to specified exit direction)			
Beam roundness		>90%				
Beam pointing stability	<25 µrad					
Polarization ratio	Horizontal; >100:1					
	Operatio	onal Specifications and Charac	teristics			
Interface	RS232, Eth	ernet, Software GUI, External TTI	_ Triggering			
Warm-up time	< 5 minutes from standby, <15 minutes from cold start					
Electrical requirement	32 V DC, 15 A	32 V DC, 28 A	60/32 V DC, 20/18 A			
Line frequency	50-60 Hz					
Power consumption	<500W	<900W	<1300W			
Dimensions	16 x 8.5 x 4.5 in. [406.4 x 215.9 x 114.3mm]	20 x 8.5 x 4.5 in. 20 x 10 x 4.5 [508 x 215.9 x 114.3mm] [508 x 254 x 114.3mm]				
Weight	~38lbs [17.2kg]	~47lbs [21.3kg]	~57lbs [25.9kg]			
		Environmental Requirements				
Ambient temperature 4	Ambient 15°C to 30°C (59°F to 86°F) Operating Range					
Ambient temperature ⁴	Relative humidity 0% to 80% max, non-condensing					
Storage conditions	-10°C to 40°C; sea level to 12000 m					
Storage conditions	0% to 8	30% relative Humidity, non-cond	ensing			
Cooling system		Water-Cooled				

[1] Specification is based on 1MHz optimized performance data. [2] Specifications for power and pulse energy are provided for specific repetition rates and are not achievable simultaneously. The listed power and pulse energy apply exclusively to their respective repetition rates. Please inform Photonics Industries of your desired operational PRF (kHz) when placing your order. [3] Measured over 8 hours ± 2°C. [4] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate *Illustration includes some simulated data for conceptual visualization.

Typical Beam Profile







Specifications – RX Series

	RX-355-10	RX-355-28	RX-355-50			
Wavelength		355nm				
Average Power @ 1MHz ¹	10W	28W	50W			
Pulse Energy @100kHz ²	لµ08~	~200µJ	~280µJ			
Pulse Width		~7ps				
Pulse repetition rate		Single shot to 2MHz				
Pulse-to-pulse stability		<2% rms				
Long-term power stability ³		≤1% rms				
Beam spatial mode & M ^{2 †}		TEM ₀₀ – M ² <1.2				
Beam divergence (nominal)		<1 mrad				
Beam bore sight accuracy	≤ 1 mm lateral (to specified	l exit location), ≤ 5 mrad angula	ar (to specified exit direction)			
Beam roundness		>90%				
Beam pointing stability	<25 µrad					
Polarization ratio	Vertical; >100:1 Horizontal; >100:1					
	Operational Specifications and Characteristics					
Interface	RS232, Eth	ernet, Software GUI, External T	TL Triggering			
Warm-up time	< 5 minutes from standby, <15 minutes from cold start					
Electrical requirement	32 V DC, 15 A	32 V DC, 28 A 60/32 V DC, 20/1				
Line frequency		50-60 Hz				
Power consumption	<500W	<900W <1300W				
Dimensions	16 x 8.5 x 4.5 in. 25.5 x 10 x 4.5 in [406.4 x 215.9 x 114.3mm] [647.7 x 254 x 114.3mm]					
Weight	~38lbs [17.3kg]	~71lbs [32.2kg]				
	Environmental Requirements					
Ambient temperature ⁴	Ambient 15°C to 30°C (59°F to 86°F) Operating Range					
	Relative humidity 0% to 80% max, non-condensing					
Storago conditions	-1	-10°C to 40°C; sea level to 12000 m				
Storage conditions	0% to 8	30% relative Humidity, non-cor	ndensing			
Cooling system		Water-Cooled				

[1] Specification is based on 1MHz optimized performance data. [2] Specifications for power and pulse energy are provided for specific repetition rates and are not achievable simultaneously. The listed power and pulse energy apply exclusively to their respective repetition rates. Please inform Photonics Industries of your desired operational PRF (kHz) when placing your order. [3] Measured over 8 hours ± 2°C. [4] For operation of the laser outside of the specified temperature range, contact PI. [†] ALL beam parameters and stability are at specification 1MHz repetition rate *Illustration includes some simulated data for conceptual visualization.

Typical Beam Profile



Power Vs. PRF Power (W) PRF (kHz)







Options:	

High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Multi-wavelength	Multi-wavelength output, blended or selectable	[MWB], [MWS]
Deep Ultraviolet (DUV)	266nm Wavelength available upon request	

Format	RX-1064/532/355/266	-	[Power Level]	-	[XXX]
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Options:		
High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Multi-wavelength	Multi-wavelength output	[MWB]

FormatRX-1064/532-[Power Level]-[xxx]	- [XXX]
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Options:		
High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Multi-wavelength	Multi-wavelength output, blended	[MWB]

	Format	RX-1064/532	-	[Power Level]	-	[XXX]
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Options:		
High PRF	Up to 15 MHz operational pulse repetition rate	[15M]
Quasi-CW	~32 MHz fixed pulse repetition rate	[QCW]
Deep Ultraviolet (DUV)	266nm Wavelength available upon request *Dimensions may vary	

Format	RX-355	-	[Power Level]	-	[XXX]





Format		RX-355	-	[Power Level]	-	[XXX]
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Our ongoing policy is to improve the design and specification of our products. The information provided is non-binding. © 2024 Photonics Industries International, Inc. Headquarters: 1800 Ocean Ave, Ronkonkoma, New York 11779, United States Photonics Industries International, Inc.

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RoHS

Photonics Industries International Inc. is the pioneer of intracavity harmonic lasers and is at the forefront of developing, manufacturing, and marketing a wide range of nanosecond, sub-nanosecond, picosecond, and femtosecond lasers for the industrial, scientific, defense and medical industries.

For more information www.photonix.com

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Rayture Systems



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